

IMISC499

SYSTEM CLOCK CHIP

July 1995
Preliminary

CMOS LSI
PLL FREQUENCY SYNTHESIZER

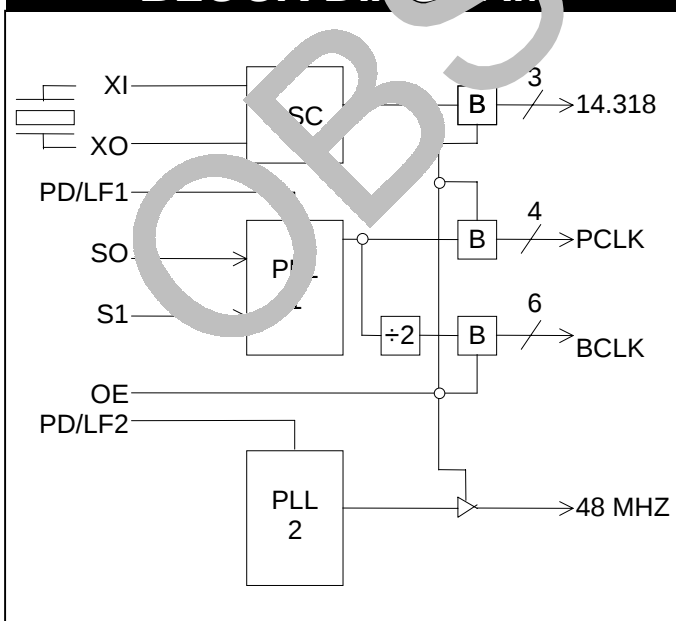
PRODUCT FEATURES

- Integrates clock generator and distribution buffers
- 3.3V to 5V operating supply range
- Supports Pentium™ based designs
- 200 ps typical buffer skew
- Supports USB (Universal Serial Bus)
- 28 Pin SOIC
- Power down and tristate inputs

FREQUENCY TABLE

S0	S1	PCLK
0	0	50 MHz
0	1	60 MHz
1	0	66 MHz

BLOCK DIAGRAM



PRODUCT DESCRIPTION

The IMISC499 provides the clock frequencies and clock distribution buffers required on a Pentium™ synchronous PC system board. The SC499 contains PLL's for fixed and programmable clocks, fan-out buffers for the CPU and PCI busses, and operates from a 3.3 or 5V power source. The frequency selection of the PCLK outputs is determined by the S0-S1 pins. The on-chip buffers provide the low skew performance required by the CPU and PCI busses.

CONNECTION DIAGRAM

PD/LF1	1	28	REF0
Xin	2	27	REF1
Xout	3	26	PD/LF2
VSS	4	25	REF2
OE	5	24	48 MHz
PCLK0	6	23	VSS
PCLK1	7	22	BCLK2
VDD	8	21	BCLK3
PCLK2	9	20	VDD
PCLK3	10	19	BCLK4
AVSS	11	18	BCLK5
S1	12	17	VSS
S0	13	16	BCLK1
AVDD	14	15	BCLK0

APPLICATIONS

The IMISC499 supports synchronous Pentium™ designs by providing clock distribution for the CPU and PCI bus and system fixed frequencies. The performance, functionality, and pin out conform to the Intel Mars and Triton II core logic requirements.

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PIN DESCRIPTIONS

Xin and Xout- These pins form an on-chip reference oscillator when connected to terminals of an external parallel resonant crystal of 14.31818 at 12 PF load. Xin may also serve as an input for an externally generated CMOS reference signal.

OE- Output enable. When OE is high, all clock outputs are enabled. When OE is low, all clock outputs are tristated. This input has internal pull-up resistor to VDD.

PCLK0, PCLK1, PCLK2, and PCLK3- CPU bus clock outputs.

BCLK0, BCLK1, BCLK2, BCLK3, BCLK4, and BCLK5- PCI bus clock outputs. These are one-half the frequency of PCLK.

48 MHz - 48 MHz USB clock output

REF0, REF1, and REF2- 14.31818 MHz clock outputs.

S1 and S0- Frequency select inputs. These inputs select the frequency of the PCLK and BCLK outputs. Both have internal pull-down resistors to VSS.

VSS(2)- Circuit grounds.

VDD(2)- Positive power supplies.

AVSS- Analog circuit ground.

AVDD- Analog positive power supply.

SC 499 FREQUENCY SELECT TABLE

S0	S1	XIN	PCLK	BCLK	REF	48 MHz
0	0	14.318	50	25	14.318	48
0	1	14.318	60	30	14.318	48
1	0	14.318	66	33	14.318	48
1	1	TCLK	TCLK/2	TCLK/4	TCLK	TCLK

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MAXIMUM RATINGS

Voltage Relative to VSS	-0.3 to 6V
Voltage Relative to VDD	0.3V
Storage Temperature:	-65°C to +150°C
Ambient Temperature:	-0°C to +70°C
Recommended Operating Range	3V - 6V

This device contains circuitry to protect the inputs against damage due to high static voltages or electric field; however, precautions should be taken to avoid application of any voltage higher than the maximum rated voltages to this circuit. For proper operation, Vin and Vout should be constrained to the range:

$$VSS < (V_{in} \text{ or } V_{out}) < VDD$$

Unused inputs must always be tied to an appropriate logic voltage level (either VSS or VDD).

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Min	Typ	Max	Units	Conditions
Input Low Voltage	VIL	-	-	0.8	Vdc	OE, S0-S1 Inputs
Input High Voltage	VIH	2.0	-	-	Vdc	OE, S0-S1 Inputs
Input Low Current with Pull up or Pull-down	IIL	-	-	5 ±50	uA	OE, S0-S1 Inputs
Input High Current with Pull-up or Pull-down	IIH	-	-	5 ±50	uA	OE, S0-S1 Inputs
Output Low Voltage IOL = 6mA*	VOL	-	-	0.4	Vdc	All Outputs
Output High Voltage IOH=6mA*	VOH	2.4	-	-	Vdc	All Outputs
Tri-State Leakage Current	IOZ	-	-	10	uA	LF1 and LF2 and All Outputs
Dynamic Supply Current	ICC	-	-	30*	mA	PCLK = 66 MHz
Short Circuit Current	ISC	25	-	-	mA	

VDD = ±3.1 to ±5.5V, TA = 0°C to +70°C

* Valid for +3.1V to +3.6V operation only.

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SWITCHING CHARACTERISTICS

Characteristic	Symbol	Min	Typ	Max	Units	Conditions
Output Rise (0.8V - 2.0V) and Fall (2.0V-0.8V) time All Outputs	t _{TLH} , t _{THL}	-	-	1.5*	ns	15 pf Load
Output Duty Cycle		45	50/50	55	%	Measured at 1.5V
Skew PCLK to BCLK	t _{SKEWP} B	1.0*	-	4*	ns	15 pf Load Measured at 1.5V
Buffer out Skew PCLK or BCLK	t _{SKEW}	-	-	250	ps	15 pf Load Measured at 1.5V
ΔPeriod Adjacent Cycles PCLK	ΔP	-	±200	-	ps	-
Jitter Absolute PCLK and REF	t _{jab}	-	±200	-	ns	-
Input Rise/Fall Time S0-S1		-	-	2	us	-
Switching Current Low: REFO, PCLK, BCLK Outputs Other Outputs	IOL (AC) IOL (AC)	-	60 20*	-	mA mA	= 1.5V 1.5V VOL =
Switching Current High: REFO, PCLK, BCLK Outputs Other Outputs	IOH (AC) IOH (AC)	-	50* 28*	-	mA mA	= 1.5V 1.5V VOL =
VDD = +3.1V to +5.5V, TA = 0°C to 70°C						

* Valid for +3.1V to +3.6V operation only.

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APPLICATION DIAGRAM

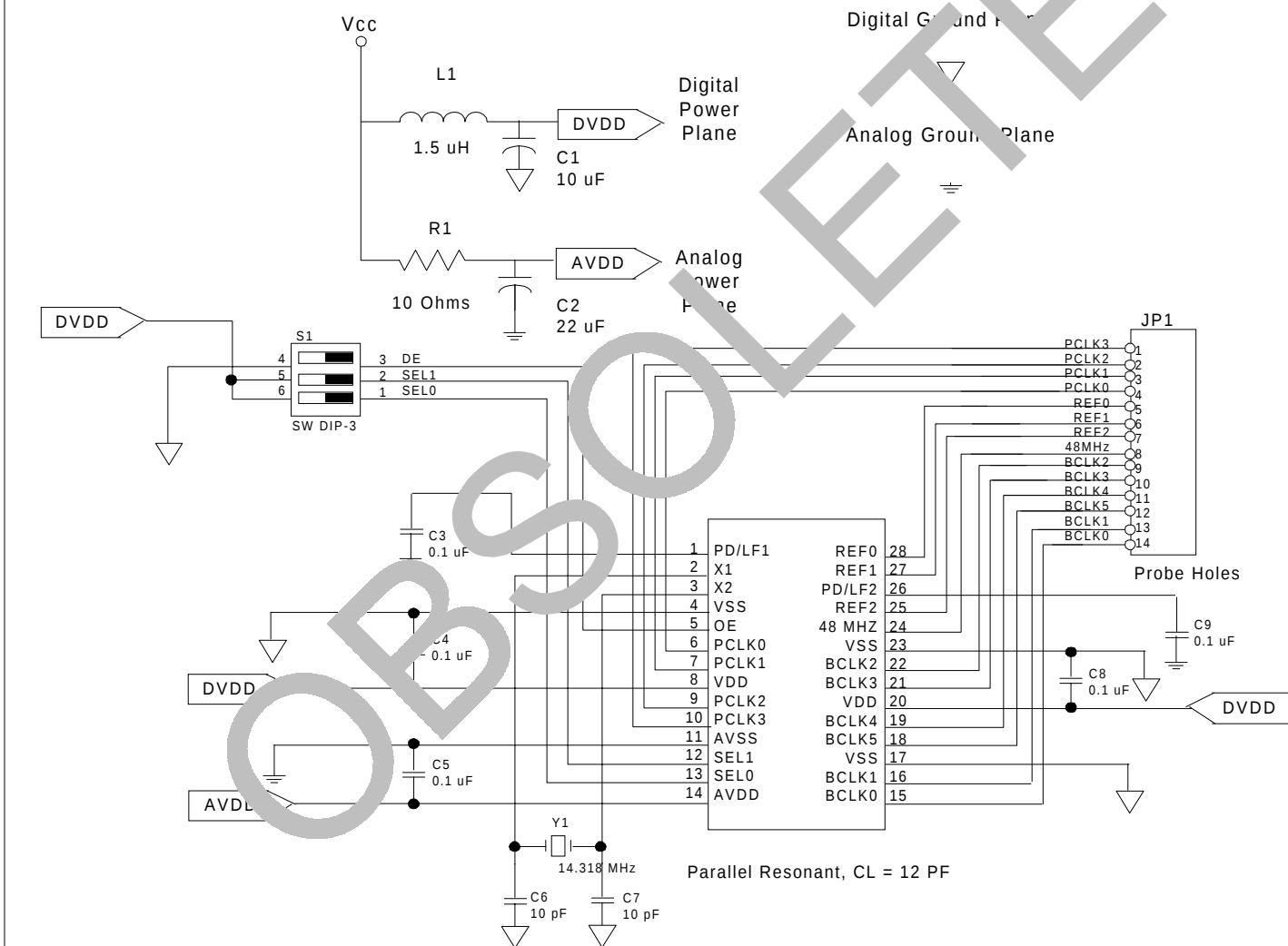
NOTE 1: CONNECT DIGITAL GROUND AND ANALOG GROUND THROUGH ONE POINT ONLY ON PC BOARD.

NOTE 2: C4 AND C5 - C8 MUST BE CLOSE TO THEIR PINS.

NOTE 3: C3 AND C9 SHOULD CONNECT TO AVSS INDEPENDENT OF CONNECTION CARRYING CURRENT FROM AVSS TO SYSTEM GROUND.

NOTE 4: IF VCC AT CLOCK GENERATOR CONTAINS POSITIVE VOLTAGE STEPS > OR -100 MV WITHIN 5 US (FROM TURNING DISK DRIVE OFF, ETC.), THE VALUES OF L1, C1, AND C2 SHOULD BE INCREASED APPROXIMATELY 100% TO AVOID OUT-OF-SPEC SHORT CLOCK CYCLES.

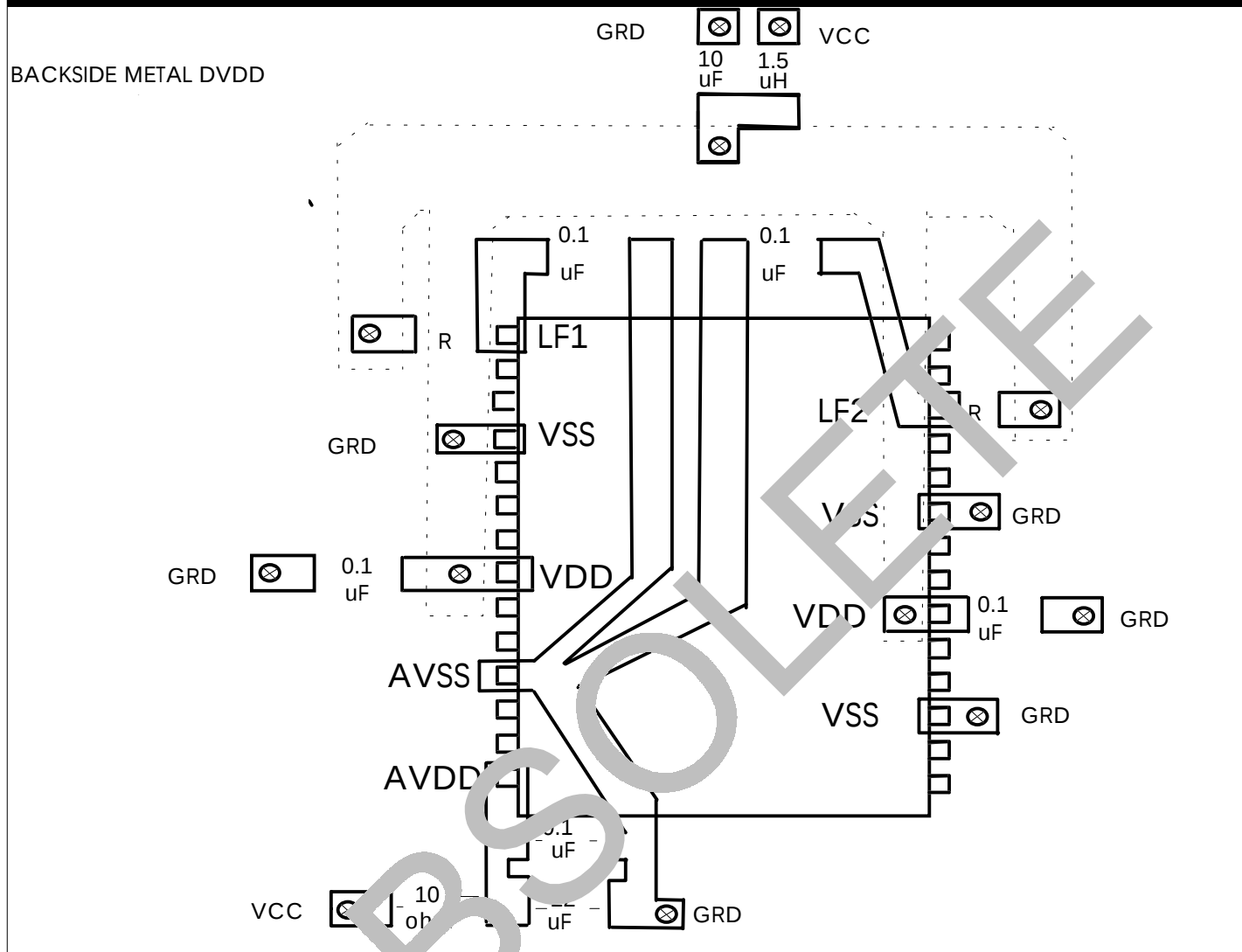
NOTE 5: VALUES OF C6 AND C7 MUST BE INCREASED TO INSURE FREQUENCY ACCURACY FOR CRYSTALS TUNED AT CL HIGHER THAN 12 PF.



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PCB LAYOUT SUGGESTION



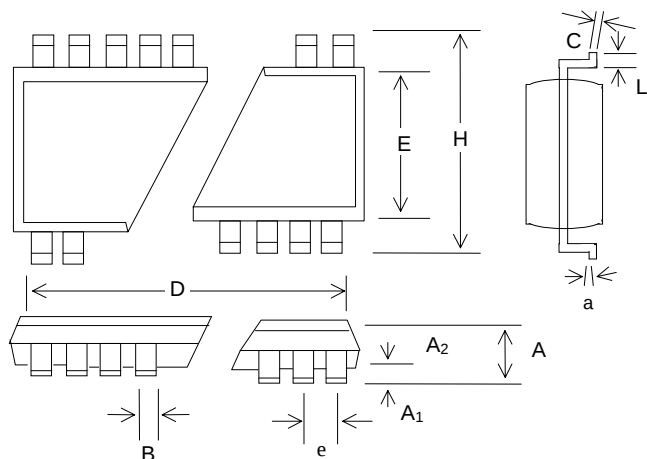
NOTES

- 1) This layout accommodates IMI technology while maintaining pin compatibility with other vendors' products designed to the Intel clock generator spec. R = • for IMI; R = 0 for other vendors.
- 2) Separate top layer traces and filtering to AVDD and AVSS produce the best performance for IMI clock generators.

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PACKAGE DRAWING AND DIMENSIONS



28 PIN SOIC OUTLINE DIMENSIONS

SYMBOL	INCHES			MILLIMETERS		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.097	0.101	0.104	2.46	2.56	2.64
A ₁	0.005	0.009	0.0115	0.127	0.22	0.29
A ₂	0.090	0.092	0.094	2.29	2.34	2.39
B	0.014	0.016	0.019	0.35	0.41	0.48
C	0.009	0.010	0.0125	0.229	0.254	0.32
D	0.701	0.703	0.711	17.81	17.93	18.06
E	0.292	0.296	0.299	7.42	7.52	7.59
e	0.050 BSC			1.27 BSC		
H	0.400	0.406	0.410	10.16	10.31	10.41
a	0°	5°	8°	0°	5°	8°
L	0.024	0.032	0.040	0.61	0.81	1.02

ORDERING INFORMATION

Part Number	Package Type	Production Flow
IMISC499xB	28 PIN SOIC	Commercial, 0°C to + 70°C

Note: The "x" following the IMI Device Number denotes the device revision. The ordering part number is formed by a combination of device number, device revision, package style, and screening as shown below.

Marking: Example: IMI
SC499xB
Date Code, Lot #

IMISC499xB

